

- Delay Elements for Generating Delay Lines
- Inverting and Non-inverting Elements
- Buffer NAND Elements Rated at I_{OL} of 12/24 mA
- PNP Inputs Reduce Fan-In ($I_{IL} = -0.2$ mA MAX)
- Worst Case MIN/MAX Delays Guaranteed Across Temperature and V_{CC} Ranges

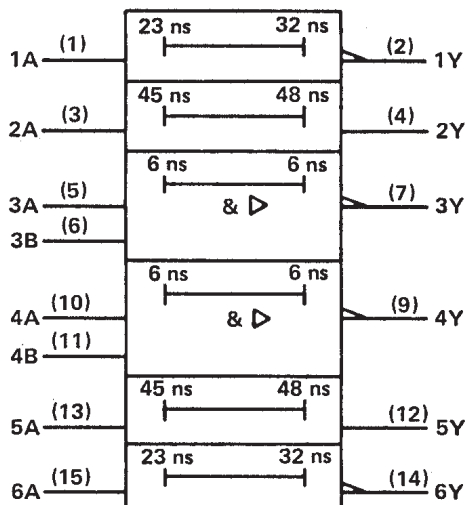
description

These 'LS31 delay elements are intended to provide well-defined delays across both temperature and V_{CC} ranges. Used in cascade, a limitless range of delay gating is possible.

All inputs are PNP with I_{IL} MAX of -0.2 mA. Gates 1, 2, 5, and 6 have standard Low-Power Schottky output sink current capability of 4 and 8 mA I_{OL} . Buffers 3 and 4 are rated at 12 and 24 mA.

The SN54LS31 is characterized for operation over the full military temperature range of -55°C to 125°C . The SN74LS31 is characterized for operation from 0°C to 70°C .

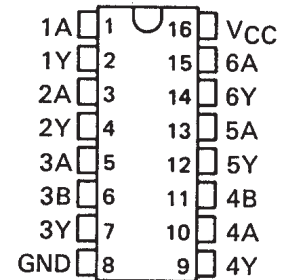
logic symbol†



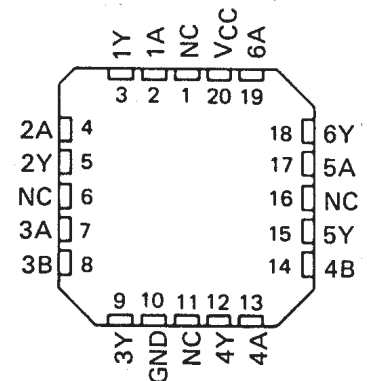
† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

Pin numbers shown are for D, J, N, and W packages.

SN54LS31 . . . J OR W PACKAGE
SN74LS31 . . . D OR N PACKAGE
(TOP VIEW)



SN54LS31 . . . FK PACKAGE
(TOP VIEW)

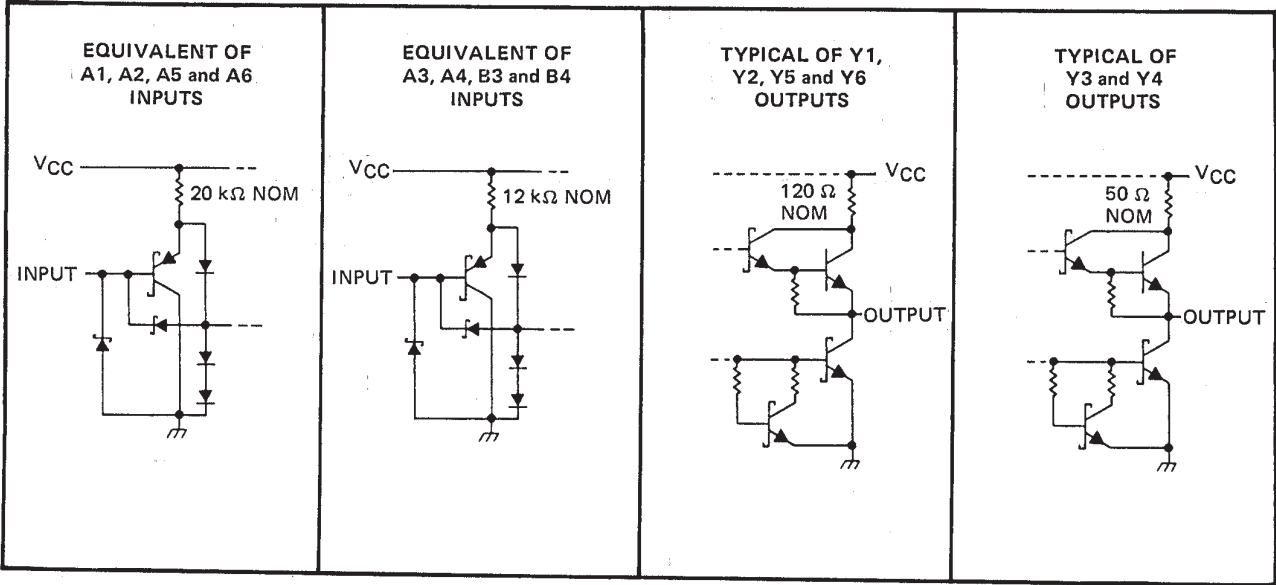


NC - No internal connection

SN54LS31, SN74LS31
DELAY ELEMENTS

SDLS157 – DECEMBER 1983 – REVISED MARCH 1988

Delay Element	Logic	Typical Delays			Rated I _{OL}
		t _{PLH}	t _{PHL}	AVG.	
Gates 1 and 6	Inverting	32 ns	23 ns	27.5 ns	4 and 8 mA
Gates 2 and 5	Non-Inverting	45 ns	48 ns	46.5 ns	4 and 8 mA
Buffers 3 and 4	2-Input NAND	6 ns	6 ns	6 ns	12 and 24 mA



absolute maximum ratings over operating free air temperature range (unless otherwise noted)

Supply voltage, V _{CC} (See Note 1)	7 V
Input voltage, V _I : All inputs	7 V
Operating free-air temperature range: SN54LS31	– 55° C to 125° C
SN74LS31	0° C to 70° C
Storage temperature range	– 65° C to 150° C

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

		SN54LS31			SN74LS31			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
V _{CC}	Supply voltage	4.5	5	5.5	4.75	5	5.25	V
V _{IH}	High-level input voltage	2			2			V
V _{IL}	Low-level input voltage			0.7			0.8	V
I _{OH}	High-level output current			– 1.2			– 1.2	mA
				– 0.4			– 0.4	
I _{OL}	Low-level output current			12			24	mA
				4			8	
T _A	Operating free-air temperature	– 55		125	0		70	° C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS†				SN54LS31		SN74LS31		UNIT
						MIN	TYP‡	MAX	MIN	
V _{IK}		V _{CC} = MIN, I _I = - 18 mA				- 1.5		- 1.5		V
V _{OH}		V _{CC} = MIN, V _{IH} = 2 V, V _{IL} = MAX	Y3, Y4	I _{OH} = - 1.2 mA		2.4	3.1	2.4	3.1	V
			Others	I _{OH} = - 0.4 mA		2.5	3.1	2.7	3.1	
V _{OL}		V _{CC} = MIN, V _{IH} = 2 V, V _{IL} = MAX	Y3, Y4	I _{OL} = 12 mA		0.25 0.4		0.25 0.4		V
				I _{OL} = 24 mA				0.35 0.5		
			Others	I _{OL} = 4 mA		0.25 0.4		0.25 0.4		
				I _{OL} = 8 mA				0.35 0.5		
I _I		V _{CC} = MAX, V _I = 7 V				0.1		0.1		mA
I _{IH}		V _{CC} = MAX, V _I = 2.7 V				20		20		μA
I _{IL}		V _{CC} = MAX, V _I = 0.4 V				- 0.2		- 0.2		mA
I _{OS} §		V _{CC} = MAX, A3, A4, B3, B4 = 0 V			Y3, Y4	- 30	- 130	- 30	- 130	mA
		V _{CC} = MAX, A1, A6 = 0 V, A2, A5 = 4.5 V			Y1, Y2, Y5, Y6	- 20	- 100	- 20	- 100	
I _{CC}	I _{CCH}	V _{CC} = MAX, A2, A5 = 4.5 V, all other inputs 0 V				2.3	4	2.3	4	mA
	I _{CCL}	V _{CC} = MAX, A2, A5 = 0 V, all other inputs 4.5 V				13	20	13	20	

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

‡ All typical values are at $V_{CC} = 5 \text{ V}, T_A = 25^\circ\text{C}$.

§ Not more than one output should be shorted at a time and the duration of the short-circuit should not exceed one second.

switching characteristics, (see note 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	SN54LS31			SN74LS31			UNIT
			MIN	TYP	MAX	MIN	TYP	MAX	
t_{PLH}	A1, A6	Y1, Y6	15		70	22		65	ns
t_{PHL}			9		50	13		45	
t_{PLH}	A2, A5	Y2, Y5	22		90	31		80	ns
t_{PHL}			20		105	30		95	
t_{PLH}	A3, B3, A4, Y4	Y3, Y4	2		20	2		15	ns
t_{PHL}			2		20	2		15	

NOTE 2: $V_{CC} = \text{MIN to MAX}$

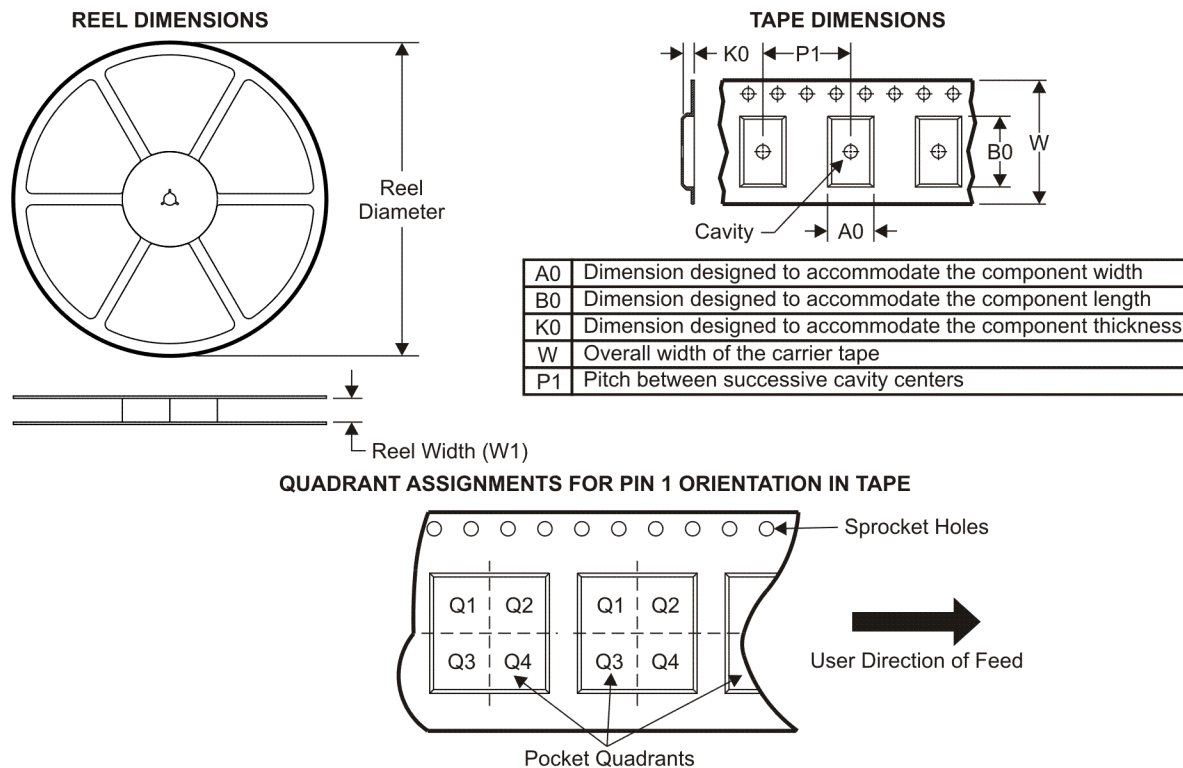
$R_L = 667 \Omega, C_L = 45 \text{ pF}$ for Y3 and Y4.

$R_L = 2 \text{ k}\Omega, C_L = 15 \text{ pF}$ for Y1, Y2, Y5 and Y6.

$T_A = \text{MIN to MAX}$

Load circuits and voltage waveforms are shown in Section 1.

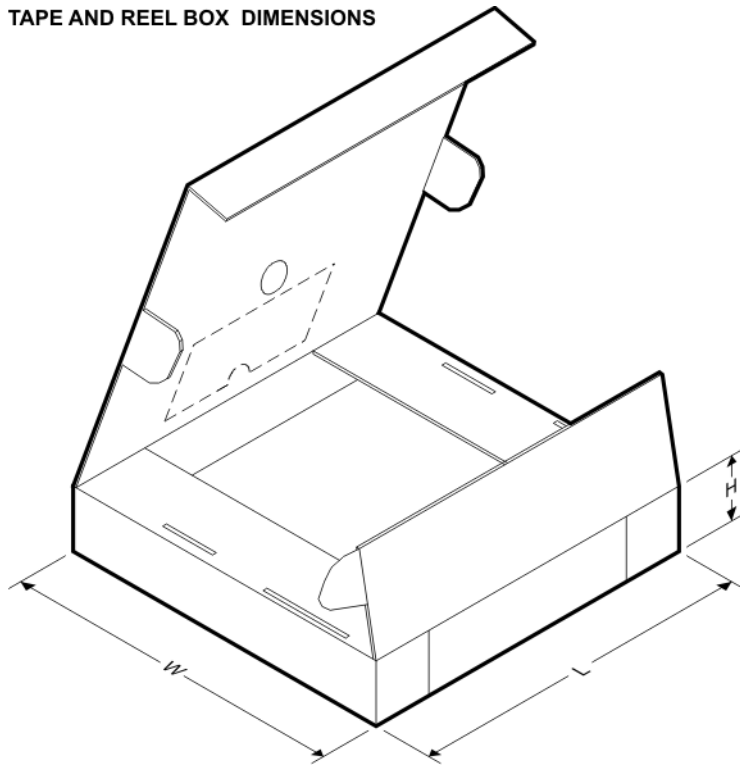
TAPE AND REEL INFORMATION



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LS31DR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
SN74LS31NSR	SO	NS	16	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LS31DR	SOIC	D	16	2500	333.2	345.9	28.6
SN74LS31NSR	SO	NS	16	2000	346.0	346.0	33.0

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